Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_q max. (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.93

650

48

12

19

Single

 $V_{GS} = 10 V$

FEATURES

· Low gate charge Qg results in simple drive requirement



- Improved gate, avalanche, and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- · High speed power switching

TYPICAL SMPS TOPOLOGIES

- Single transistor flyback
- · Single transistor forward

| ORDERING INFORMATION | |
|---------------------------------|------------------|
| Package | TO-220AB |
| Lead (Pb)-free | IRFB9N65APbF |
| Lead (Pb)-free and halogen-free | IRFB9N65APbF-BE3 |

| PARAMETER | | SYMBOL | LIMIT | UNIT | |
|--|--|-------------------------|-----------------|------|----------|
| Drain-source voltage | | V _{DS} | 650 | - V | |
| Gate-source voltage | | | V _{GS} | | |
| Continuous durin coment | V _{GS} at 10 V | T _C = 25 °C | | 8.5 | |
| Continuous drain current | | T _C = 100 °C | I _D | 5.4 | А |
| Pulsed drain current ^a | | I _{DM} | 21 | | |
| Linear derating factor | | | 1.3 | W/°C | |
| Single pulse avalanche energy ^b | | E _{AS} | 325 | mJ | |
| Repetitive avalanche current ^a | | I _{AR} | 5.2 | А | |
| Repetitive avalanche energy ^a | | E _{AR} | 16 | mJ | |
| Maximum power dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$ | | PD | 167 | W | |
| Peak diode recovery dV/dt ^c | | dV/dt | 2.8 | V/ns | |
| Operating junction and storage temperature range | ating junction and storage temperature range T _J , T _{stg} | | -55 to +150 | ** | |
| Soldering recommendations (peak temperature) ^d | For | 10 s | | 300 | - °C |
| Mounting torque | 6.00 or 1 | 10 | | 10 | lbf ∙ in |
| Mounting torque | 6-32 or N | /I3 screw | | 1.1 | N · m |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Starting T_J = 25 °C, L = 24 mH, R_g = 25 Ω , I_{AS} = 5.2 A (see fig. 12) c. I_{SD} \leq 5.2 A, dl/dt \leq 90 A/µs, V_{DD} \leq V_{DS}, T_J \leq 150 °C

d. 1.6 mm from case

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IRFB9N65A

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| THERMAL RESISTANCE RATINGS | | | | |
|-------------------------------------|-------------------|------|------|------|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT |
| Maximum junction-to-ambient | R _{thJA} | - | 62 | |
| Case-to-sink, flat, greased surface | R _{thCS} | 0.50 | - | °C/W |
| Maximum junction-to-case (drain) | R _{thJC} | - | 0.75 | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|---|------------|-----------|----------|-------|
| Static | | | | | • | • | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | | 650 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Reference to 25 °C, I _D = 1 mA ^d | | - | 670 | - | mV/°C |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | | 2.0 | - | 4.0 | V |
| Gate-source leakage | I _{GSS} | $V_{GS} = \pm 30 \text{ V}$ | | - | - | ± 100 | nA |
| 7 | | V _{DS} = 650 V, V _{GS} = 0 V | | - | - | 25 | μA |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 520 \ | V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C | | - | 250 | |
| Drain-source on-state resistance | R _{DS(on)} | $V_{GS} = 10 \text{ V}$ $I_D = 5.1 \text{ A}^{\text{b}}$ | | - | - | 0.93 | Ω |
| Forward transconductance | 9 _{fs} | V _{DS} = 50 V, I _D = 3.1 A | | 3.9 | - | - | S |
| Dynamic | | | | | • | • | |
| Input capacitance | C _{iss} | | $V_{GS} = 0 V$, | - | 1417 | - | |
| Output capacitance | C _{oss} | | $V_{DS} = 25 V,$ | - | 177 | - | |
| Reverse transfer capacitance | C _{rss} | f = 1 | .0 MHz, see fig. 5 | - | 7.0 | - | |
| | | | V _{DS} = 1.0 V, f = 1.0 MHz | - | 1912 | - | pF |
| Output capacitance | C _{oss} | $V_{GS} = 0 V$ | V _{DS} = 520 V, f = 1.0 MHz | - | 48 | - | |
| Effective output capacitance | Coss eff. | | V_{DS} = 0 V to 520 V ^c | - | 84 | - | 1 |
| Total gate charge | Qg | | | - | - | 48 | |
| Gate-source charge | Q _{gs} | $V_{GS} = 10 V$ | I _D = 5.2 A, V _{DS} = 400 V see fig. 6 and 13 ^b | - | - | 12 | nC |
| Gate-drain charge | Q _{gd} | | see lig. o alla ro | - | - | 19 | 1 |
| Turn-on delay time | t _{d(on)} | | | - | 14 | - | |
| Rise time | t _r | | = 325 V, I _D = 5.2 A | - | 20 | - |] |
| Turn-off delay time | t _{d(off)} | n _g = | 9.1 Ω ,R _D = 62 Ω , see fig. 10 ^b | - | 34 | - | ns |
| Fall time | t _f | | 3 | - | 18 | - | |
| Gate input resistance | Rg | f = 1 | MHz, open drain | 0.5 | - | 3.3 | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous source-drain diode current | ١ _S | MOSFET s showing | the | - | - | 5.2 | |
| Pulsed diode forward current ^a | I _{SM} | integral re p - n junctio | | - | - | 21 | A |
| Body diode voltage | V _{SD} | T _J = 25 °C | , I _S = 5.2 A, V _{GS} = 0 V ^b | - | - | 1.5 | V |
| Body diode reverse recovery time | t _{rr} | T 05 %C 1 | | - | 493 | 739 | ns |
| Body diode reverse recovery charge | Q _{rr} | $I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$ | = 5.2 A, dl/dt = 100 A/µs ^b | - | 2.1 | 3.2 | μC |
| Forward turn-on time | t _{on} | Intrinsic tu | ırn-on time is negligible (turn | -on is dor | ninated b | v Le and | Ln) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

d. Uses SiHFIB5N65A data and test conditions

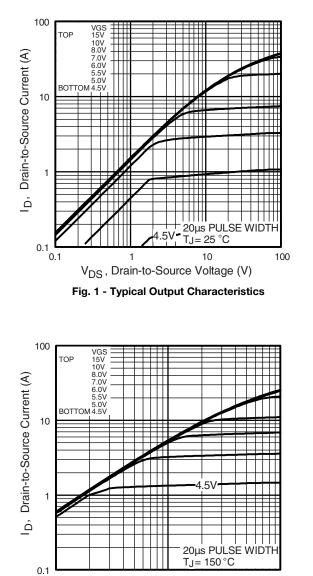
2 For technical questions, contact: <u>hvm@vishay.com</u>

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

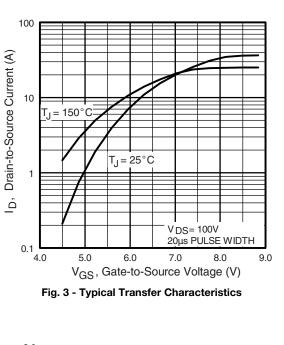


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Fig. 2 - Typical Output Characteristics

V_{DS}, Drain-to-Source Voltage (V)

100



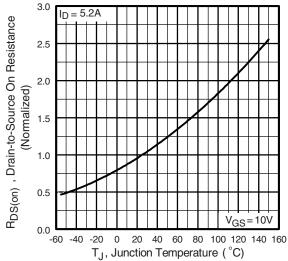


Fig. 4 - Normalized On-Resistance vs. Temperature

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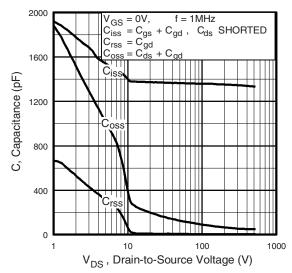


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

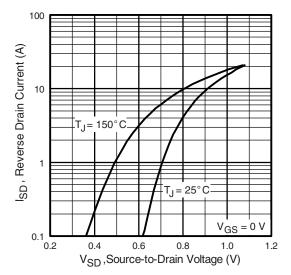


Fig. 7 - Typical Source-Drain Diode Forward Voltage

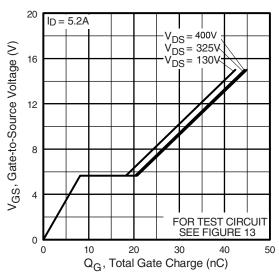


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

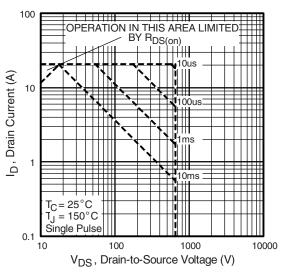


Fig. 8 - Maximum Safe Operating Area



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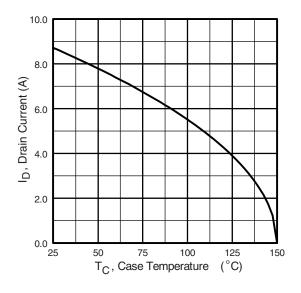


Fig. 9 - Maximum Drain Current vs. Case Temperature

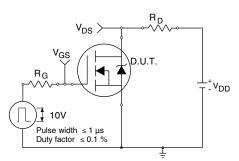


Fig. 10a - Switching Time Test Circuit

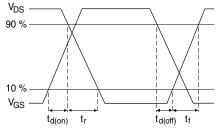
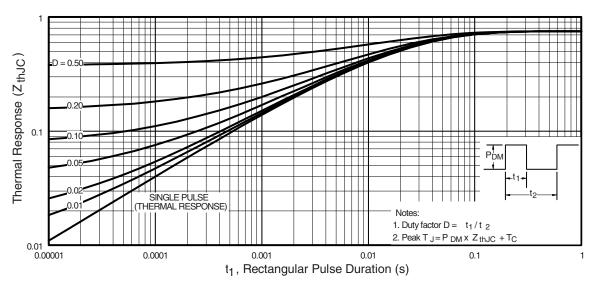


Fig. 10b - Switching Time Waveforms





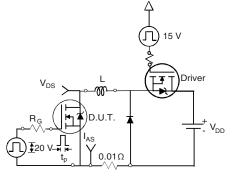


Fig. 12a - Unclamped Inductive Test Circuit

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VDS



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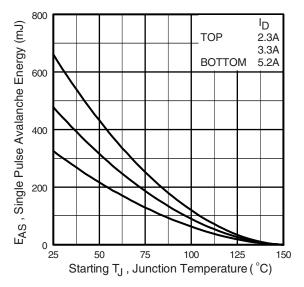
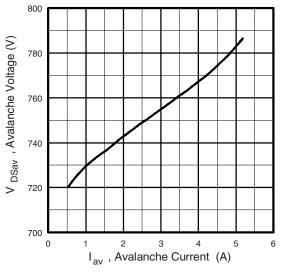
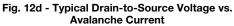


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





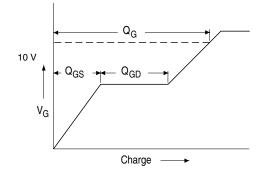


Fig. 13a - Basic Gate Charge Waveform

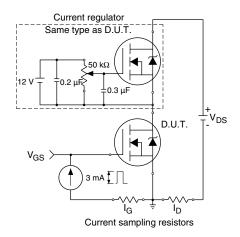
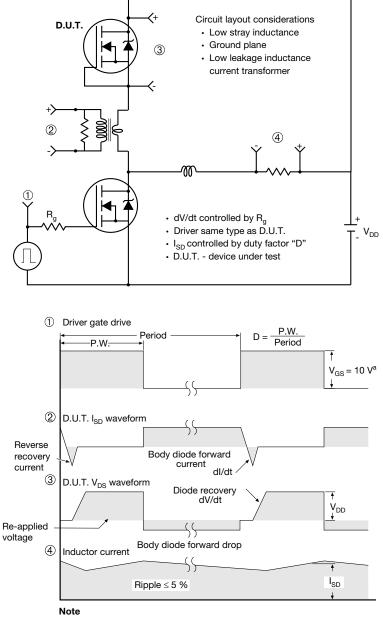


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



| DIM. | MILLIMETERS | | INCHES | | |
|------|-------------|-------|--------|-------|--|
| | MIN. | MAX. | MIN. | MAX. | |
| А | 4.24 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | |
| E | 9.96 | 10.52 | 0.392 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | |
| ØP | 3.53 | 3.94 | 0.139 | 0.155 | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | |

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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